Onsemi

MOSFET - Power, Single N-Channel, STD Gate, SO8FL

80 V, 6.2 mΩ, 71 A

NVMFWS6D2N08X

Features

- Low Q_{RR}, Soft Recovery Body Diode
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Synchronous Rectification (SR) in DC-DC and AC-DC
- Primary Switch in Isolated DC-DC Converter
- Motor Drives
- Automotive 48 V System

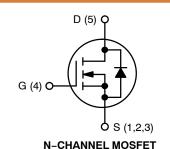
MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Value	Unit	
Drain-to-Source Voltage	V _{DSS}	80	V	
Gate-to-Source Voltage	DC	V _{GS}	±20	V
Continuous Drain Current	$T_{C} = 25^{\circ}C$	I _D	71	А
(Note 1)	$T_{C} = 100^{\circ}C$		50	
Power Dissipation (Note 1)	$T_{C} = 25^{\circ}C$	PD	68	W
Pulsed Drain Current	T _C = 25°C,	I _{DM}	265	А
Pulsed Source Current (Body Diode)	t _p = 100 μs	I _{SM}	265	А
Operating Junction and Storage Range	T _J , T _{STG}	–55 to +175	°C	
Source Current (Body Diode)	۱ _S	102	Α	
Single Pulse Avalanche Energy ((I _{PK} = 28 A)	E _{AS}	39	mJ	
Lead Temperature for Soldering (1/8" from case for 10 s)	ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Actual continuous current will be limited by thermal and electromechanical application board design.
- 3. E_{AS} of 39 mJ is based on started T_J = 25°C, I_{AS} = 28 A, V_{DD} = 64 V, V_{GS} = 10 V, 100% avalanche tested

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
80 V	$6.2~\mathrm{m}\Omega$ @ 10 V	71 A	





DFNW5 (SO-8FL) CASE 507BA



А = Assembly Location

= Year

Υ

- = Work Week
- W 77 = Assembly Lot Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

THERMAL CHARACTERISTICS

Parameter		Value	Unit
Thermal Resistance, Junction-to-Case (Note 5)	$R_{ ext{ heta}JC}$	2.22	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 4, 5)	R_{\thetaJA}	39	

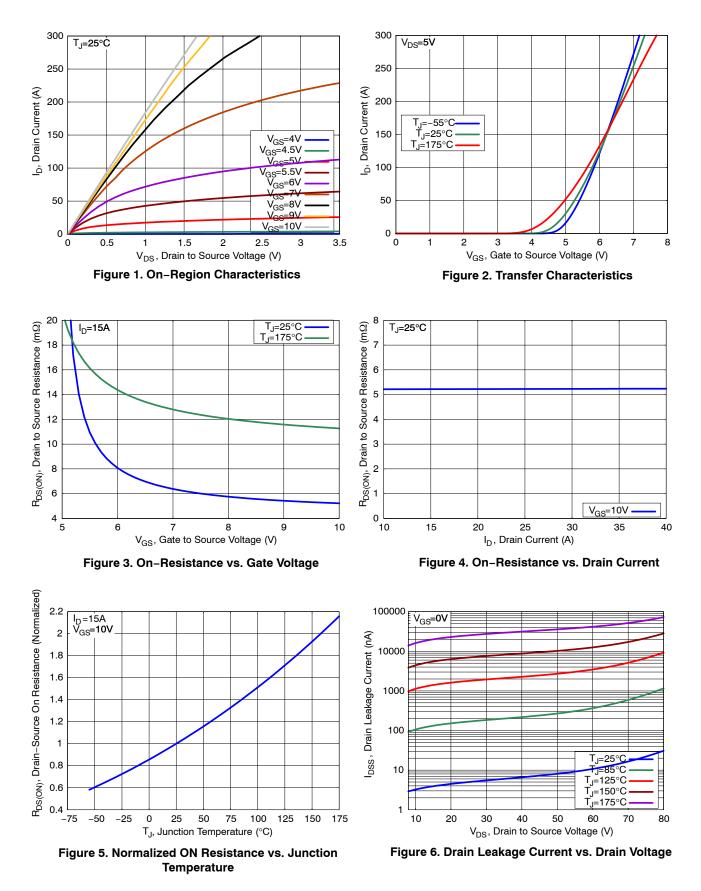
4. Surface-mounted on FR4 board using 1 in², 1 oz Cu pad. 5. $R_{\theta JA}$ is determined by the user's board design.

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

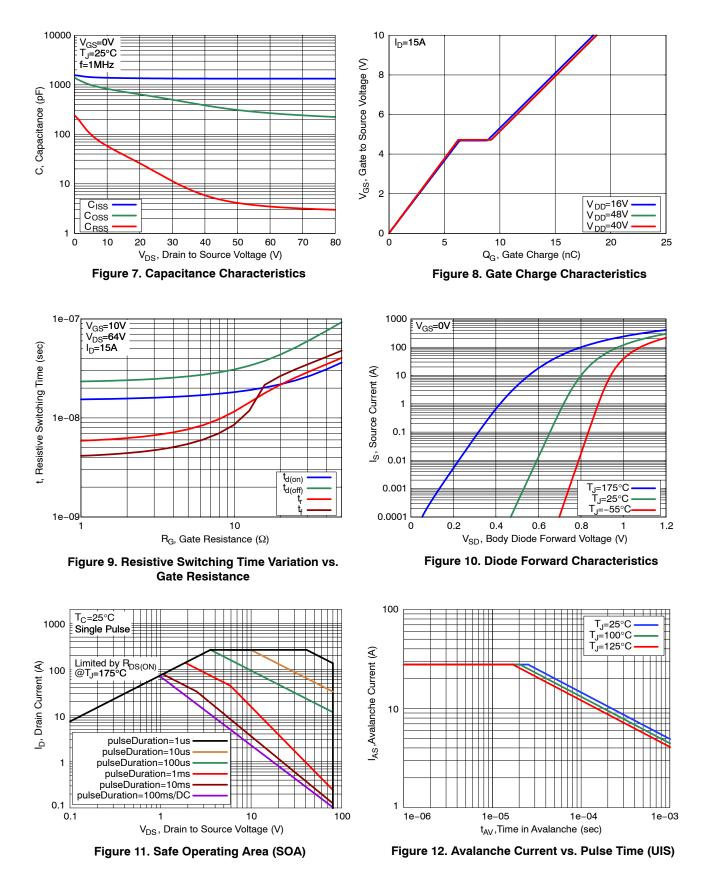
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS				-	-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA				V
Drain-to-Source Breakdown Voltage Temperature Coefficient	${\Delta V_{(BR)DSS}}/{\Delta T_J}$	$I_D = 1$ mA. Referenced to 25°C		31.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$			1	μA
		$V_{DS} = 80 \text{ V}, \text{ T}_{\text{J}} = 125^{\circ}\text{C}$			250	1
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
ON CHARACTERISTICS				-		
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 15 A		5.4	6.2	mΩ
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 75 \ \mu A$	2.4		3.6	V
Gate Threshold Voltage Temperature Coefficient	$\frac{\Delta V_{GS(TH)}}{\Delta T_J}$	$V_{GS} = V_{DS}, I_D = 75 \ \mu A$		-7.5		mV/°C
Forward Transconductance	9 _{FS}	V _{DS} = 5 V, I _D = 15 A		48		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE					
Input Capacitance	C _{ISS}			1330		pF
Output Capacitance	C _{OSS}			390		-
Reverse Transfer Capacitance	C _{RSS}	V_{GS} = 0 V, V_{DS} = 40 V, f = 1 MHz		6		
Output Charge	Q _{OSS}			28		
Total Gate Charge	Q _{G(TOT)}			19		nC
Threshold Gate Charge	Q _{G(TH)}			4		1
Gate-to-Source Charge	Q _{GS}	V_{GS} = 10 V, V_{DD} = 40 V; I_{D} = 15 A		6		
Gate-to-Drain Charge	Q _{GD}			3.0		
Gate Plateau Voltage	V _{GP}			4.7		V
Gate Resistance	R _G	f = 1 MHz		1.5		Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}			16		ns
Rise Time	tr	Resistive Load,		6		
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 0/10 V, V_{DD} = 64 V, I _D = 15 A, R _G = 2.5 Ω		24		
Fall Time	t _f			5		
SOURCE-TO-DRAIN DIODE CHARACTE	RISTICS					
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 \text{ V, } I_S = 15 \text{ A, } T_J = 25^{\circ}\text{C}$ $V_{GS} = 0 \text{ V, } I_S = 15 \text{ A, } T_J = 125^{\circ}\text{C}$		0.82	1.2	V
				0.66		1
Reverse Recovery Time	t _{RR}			18		ns
Charge Time	t _a	V _{GS} = 0 V, dl/dt = 1000 A/μs,		9		1
Discharge Time	t _b	l _S = 15 A, V _{DD} = 64 V		9		1
Reverse Recovery Charge	Q _{RR}			88		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

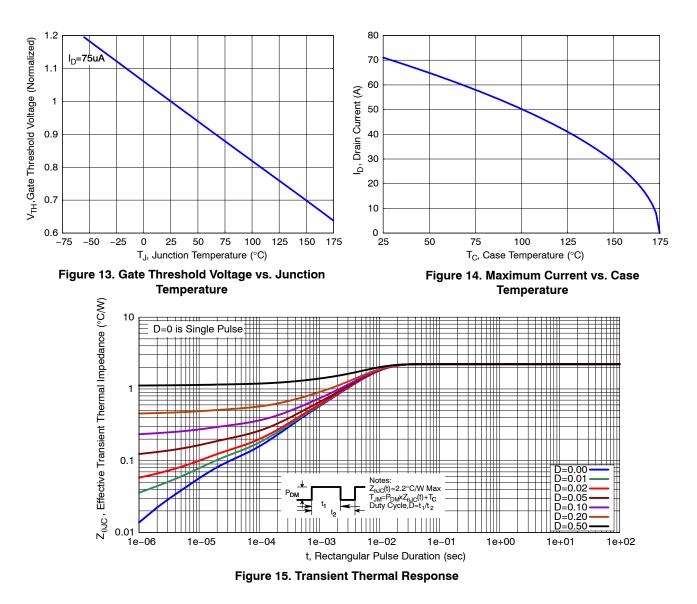
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

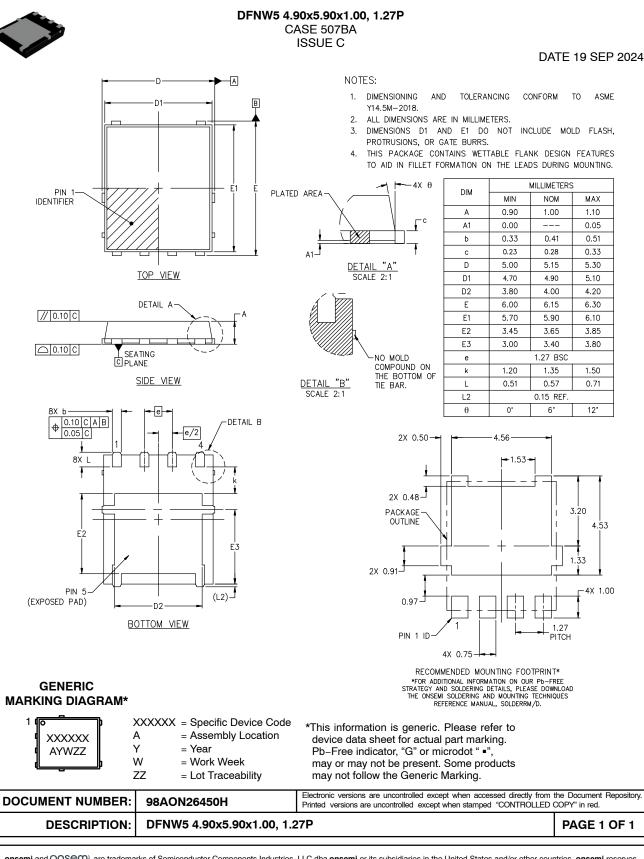


DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]	
NVMFWS6D2N08XT1G	6D2N8W DFNW5 (Pb-Free)		1500 / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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